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PATENT

REEL: 017795 FRAME: 0464

DOCKET No. <u>P57859</u>

ASSIGNMENT

AS A BELOW NAMED INVENTOR, I, and each of us, individually hereby declare that: IN CONSIDERATION of the sum of TEN (\$10.00) dollars or the equivalent thereof, and other good and valuable consideration, the receipt of which from the hereinafter named Assignee is hereby acknowledged, I do hereby sell, assign and forever grant and convey unto:

ASSIGNEE:

SAMSUNG SDI CO., LTD.,

a corporation organized under the laws of the Republic of Korea,

ADDRESS:

executed on even date herewith, or

RECORDED: 04/17/2006

575 Shin-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of KOREA

Who is my Assignee, and to the successors and assigns of my Assignee, all my right, title and interest, in and for the United States of America and all other countries, including all rights of priority, in and to the invention entitled:

TITLE: HEAT DISSIPATING STRUCTURE FOR IC CHIP OF PLASMA DISPLAY MODULE AND PLASMA DISPLAY MODULE HAVING THE SAME

invented by me (if only one inventor is named below) or us (if more than one inventor is named below) and described in an application for a United States patent the specification of which is either attached hereto or otherwise accompanies this Assignment, or is

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and in and to all United States patents which may be granted there continuations, continuations-in-part, reissued and re-examined pownership of the patent when granted, to be held and enjoyed by sother legal representatives, to the full end of the term, terms, or at granted, as fully and entirely as the same would have been held a been made:	patents, a aid SAMS ny extensi	nd to any extensions the SUNG SDI CO., LTD., no ion or renewal thereof, for	nercof, said interest being the entire my Assignee, its successors, assigns or ir which said patent or patents may be
AND I hereby covenant and agree to sign and exect documents or instruments which may from time-to-time be of prosecution of the above-named application or in the preparation division, continuation, continuation-in-part, reissue, re-examination administrative or judicial, or otherwise, to secure the title hereto in Convention for the Protection of Industrial Property, Inter-Americany other international agreement or treaty to which the United Street	ither need and pros ion, in an a said Ass can Conve	essary, lawful, proper or secution of all substitute a y amendment, extension, ignee, together with the ri ention Relating to Patents	r requested by the Assignee, in the applications, certificate of correction, or interference proceeding, whether ight of priority under the International
AND I do hereby authorize and request the Commis Assignee, and I hereby appoint as my, or our attorney, and aut Assignment any further identification or to complete such identification of the United States Patent & Trademark Office for recordati	thorize an cation wh	id request R. E. Bushnel ich may be either necessa	II, Reg. No. 27,774, to insert on this
IN WITNESS WHEREOF, I and we have set our hands	s and seal:	s on the dates written besi	ide my and our respective names:
INVENTOR(s)		Date Signed	Witness(cs)
1) Kwang-Jin JEONG (Seal) KWANG-JIN JEONG	13	April 2006	
2)(Seal)			
3)(Seal)			
Additional inventors are being named on separately numbered	sheets att	ached hereto.	
A 4/10/1996 R.E. BUSHNELL			

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